



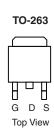
N-Channel 40-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)		
40	0.0028 at V _{GS} = 10 V	110 ^a		

FEATURES

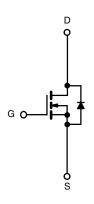
- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance





Ordering Information: SUM110N04-03

SUM110N04-03-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20	7 v	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	I-	110 ^a		
	T _C = 125 °C	l _D	110 ^a	\ \ \	
Pulsed Drain Current		I _{DM}	440	A	
Avalanche Current		I _{AR}	70		
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	211	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	В	437.5 ^c	14/	
	T _A = 25 °C	P _D	3.75	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount ^d	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4]	

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

 $^{^{\}star}$ PB containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$	40			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA
Zero Gate Voltage Drain Current		V _{DS} = 40 V, V _{GS} = 0 V			1	μΑ
	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V, T _J = 125 °C			50	
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 30 A		0.0023	0.0028	Ω
	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.0045	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.0056	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		8250		pF
Output Capacitance	C _{oss}			1380		
Reverse Transfer Capacitance	C _{rss}			850		
Total Gate Charge ^c	Q_g			165	250	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 110 \text{ A}$		45		
Gate-Drain Charge ^c	Q_{gd}			65		
Turn-On Delay Time ^c	t _{d(on)}			25	40	
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.27 Ω $I_D \cong 110$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		170	255	ns
Turn-Off Delay Time ^c	t _{d(off)}			55	85	
Fall Time ^c	t _f			110	165	
Source-Drain Diode Ratings and Cha	aracteristics 7	T _C = 25 °C ^b				
Continuous Current	I _S				110	_
Pulsed Current	I _{SM}				240	Α
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.1	1.5	V
Reverse Recovery Time	t _{rr}			60	90	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 85 A, di/dt = 100 A/μs		3.0	5	Α
Reverse Recovery Charge	Q _{rr}			0.09	0.22	μC

Notes:

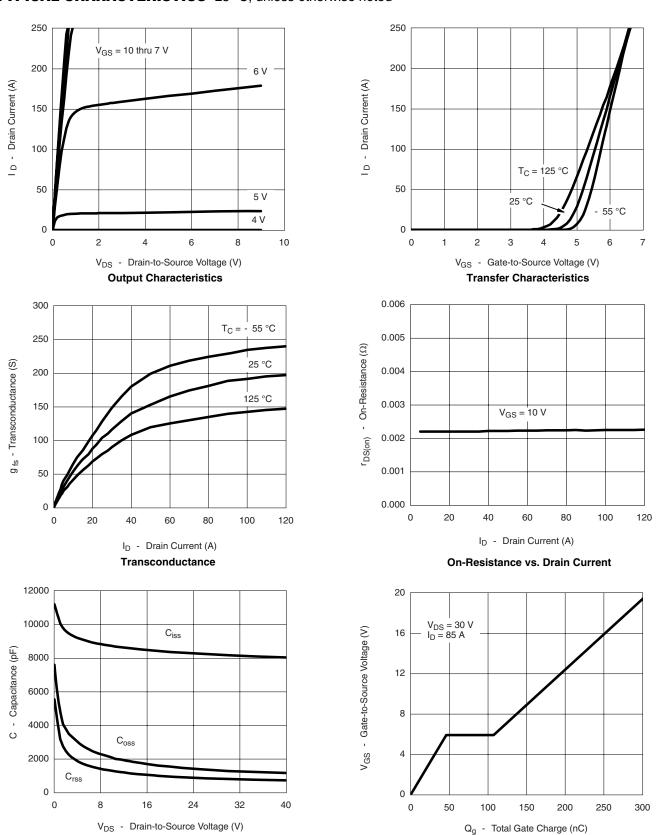
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

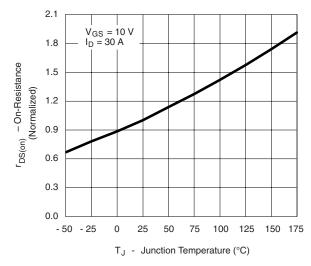


Capacitance

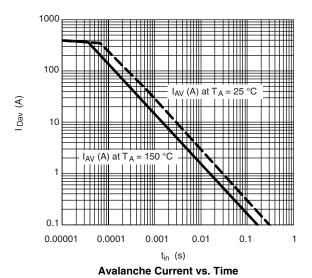
Gate Charge



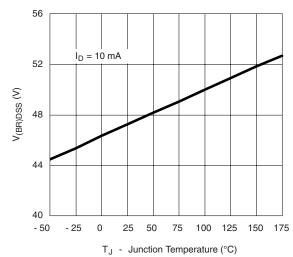
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On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



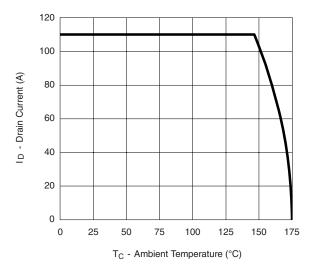
Drain Source Breakdown vs. Junction Temperature

10 μs

100 μs



THERMAL RATINGS



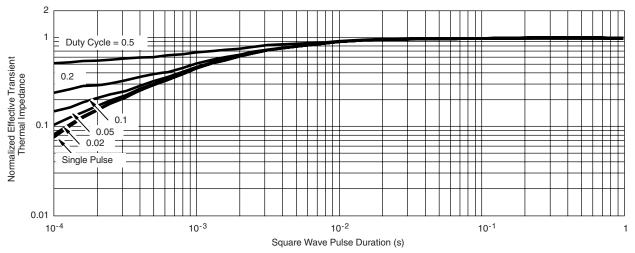
10 Limited by r_{DS(on)*} 1 ms 10 ms 100 ms 1

1000

100

Maximum Avalanche and Drain Current vs. Case Temperature

 * V_{GS} > minimum V_{GS} at which $r_{DS(on)}$ is specified **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Case

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